RENESAS

2SK2958(L), 2SK2958(S)

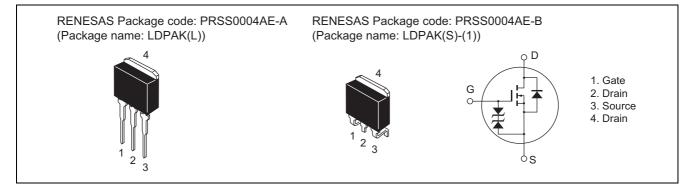
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1058-0400 (Previous: ADE-208-568B) Rev.4.00 Sep 07, 2005

Features

- Low on-resistance $R_{DS(on)} = 5.5 \text{ m}\Omega \text{ typ.}$
- 4 V gate drive devices.
- High speed switching

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	30	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	75	А
Drain peak current	I _{D(pulse)} Note1	300	A
Body-drain diode reverse drain current	I _{DR}	75	A
Channel dissipation	Pch Note2	100	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. Value at $Tc = 25^{\circ}C$

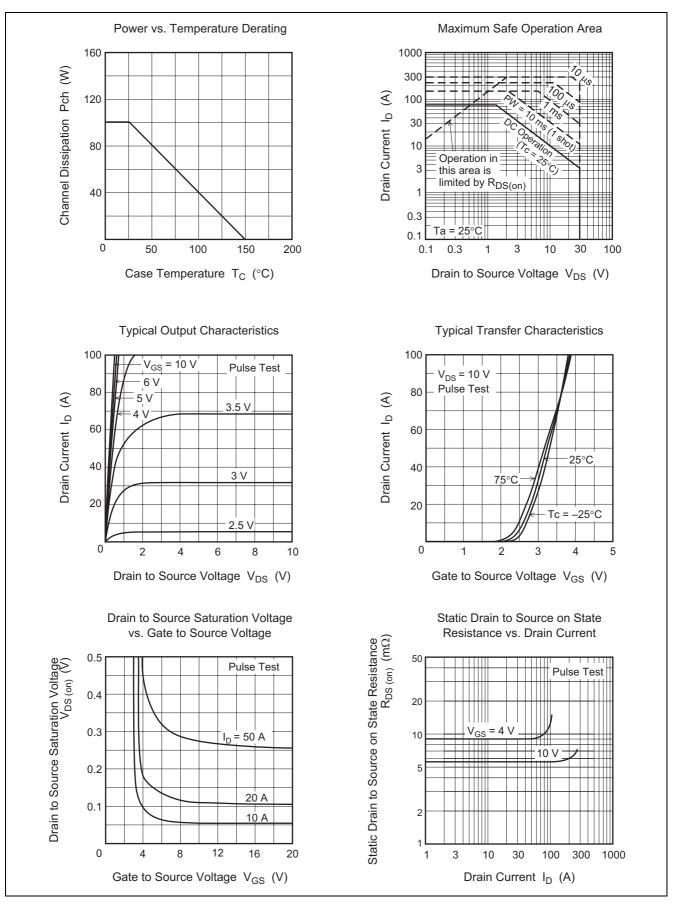
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	30	_		V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±20	—	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	—	10	μA	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0$
Gate to source leak current	I _{GSS}	_	—	±10	μΑ	$V_{GS} = \pm 1 6V, V_{DS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	1.0	—	2.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{V}$
Static drain to source on state	R _{DS(on)}	_	5.5	7.0	mΩ	$I_D = 40 \text{ A}, V_{GS} = 10 \text{V}^{\text{Note3}}$
resistance	R _{DS(on)}		9.0	14.0	mΩ	$I_D = 40 \text{ A}, V_{GS} = 4V^{Note3}$
Forward transfer admittance	y _{fs}	35	60		S	$I_D = 40 \text{ A}, V_{DS} = 10 \text{V}^{\text{Note3}}$
Input capacitance	Ciss		4100		pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$ f = 1 MHz
Output capacitance	Coss	_	2700	_	pF	
Reverse transfer capacitance	Crss	_	800	_	pF	
Turn-on delay time	t _{d(on)}		45		ns	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 40 \text{ A},$ $R_{L} = 0.25 \Omega$
Rise time	tr	_	430	_	ns	
Turn-off delay time	t _{d(off)}		460		ns	
Fall time	t _f		440		ns	
Body-drain diode forward voltage	V _{DF}		1.0		V	$I_F = 75A, V_{GS} = 0$
Body-drain diode reverse	t _{rr}		90		ns	$I_F = 75A, V_{GS} = 0$
recovery time						di _F / dt = 50 A/µs

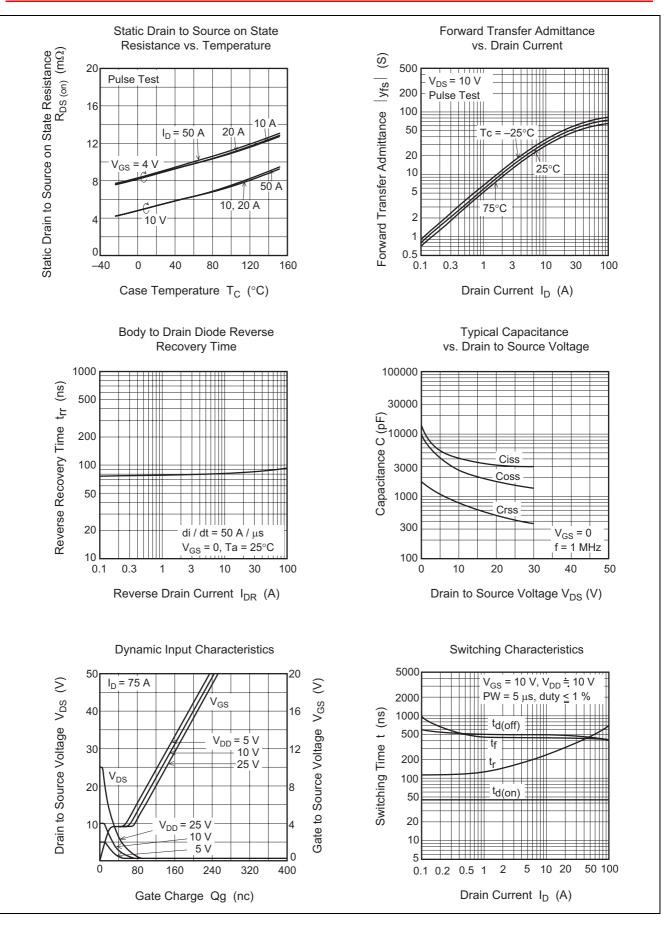
Note: 3. Pulse test



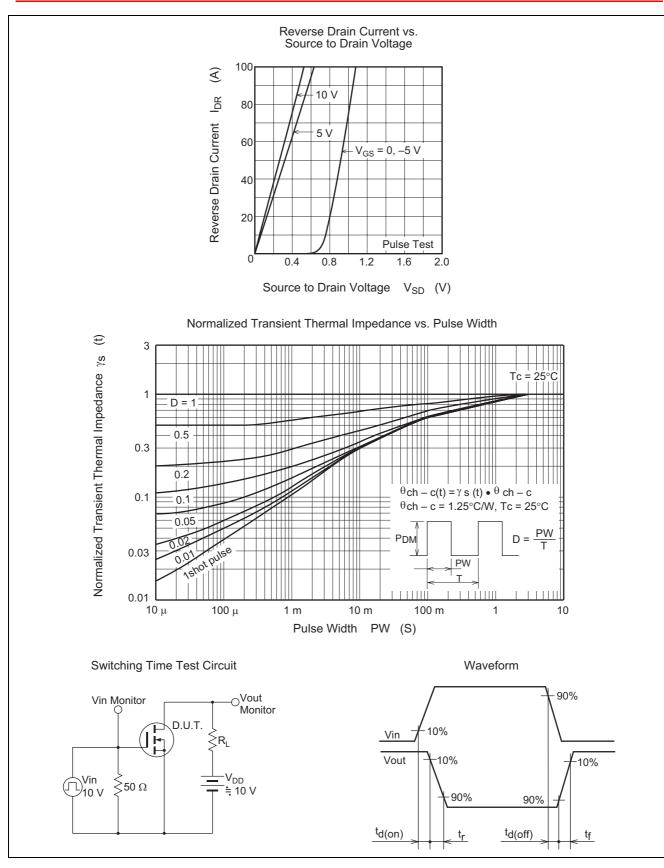
Main Characteristics





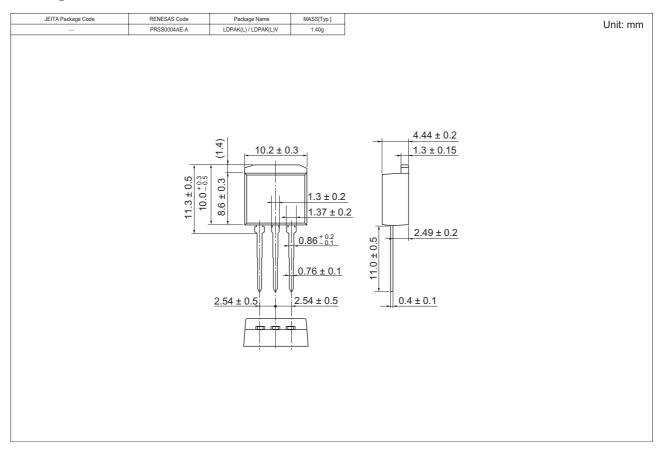


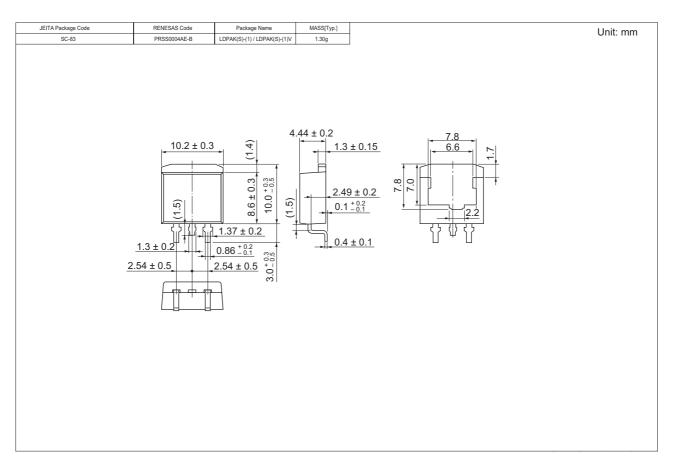






Package Dimensions







Ordering Information

Part Name	Quantity	Shipping Container
2SK2958L-E	500 pcs	Box (Sack)
2SK2958STL-E	1000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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